

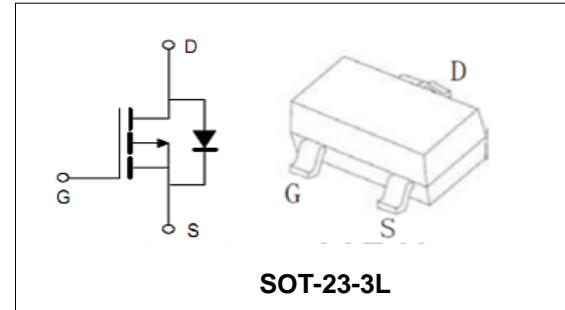
-30V/-4.2A P-Channel Enhancement Mode MOSFET
Features

- Advanced trench process technology.
- High Density Cell Design For Ultra Low On-Resistance

Applications

- Low Side Load Switch
- Battery Switch
- Optimized for Power Management Applications for Portable Products, such as Aeromodelling, Power bank, Brushless motor, Main board , and Others

| | | |
|-----------------|------|----|
| BVDSS | -30 | V |
| ID | -4.2 | A |
| RDSON@VGS=-10V | 44 | mΩ |
| RDSON@VGS=-4.5V | 57 | mΩ |
| RDSON@VGS=-2.5V | 90 | mΩ |


Order Information

| Product | Package | Marking | Reel Size | Reel | Carton |
|---------|-----------|---------|-----------|---------|-----------|
| PT3401 | SOT-23-3L | A19T | 7inch | 3000PCS | 180000PCS |

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit | |
|--|---|------------|------|------|
| Common Ratings (TC=25°C Unless Otherwise Noted) | | | | |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | -30 | V | |
| V_{GS} | Gate-Source Voltage | ± 12 | V | |
| T_J | Maximum Junction Temperature | 150 | °C | |
| T_{STG} | Storage Temperature Range | -55 to 150 | °C | |
| I_S | Diode Continuous Forward Current | TC =25°C | -4.2 | A |
| Mounted on Large Heat Sink | | | | |
| I_{DM} | Pulse Drain Current Tested (Sillicon Limit) (Note1) | TC =25°C | -30 | A |
| I_D | Continuous Drain current | TC =25°C | -4.2 | A |
| P_D | Maximum Power Dissipation | TA =25°C | 1.4 | W |
| $R_{θJA}$ | Thermal Resistance Junction-to-Ambient (Note2) | | 89.2 | °C/W |

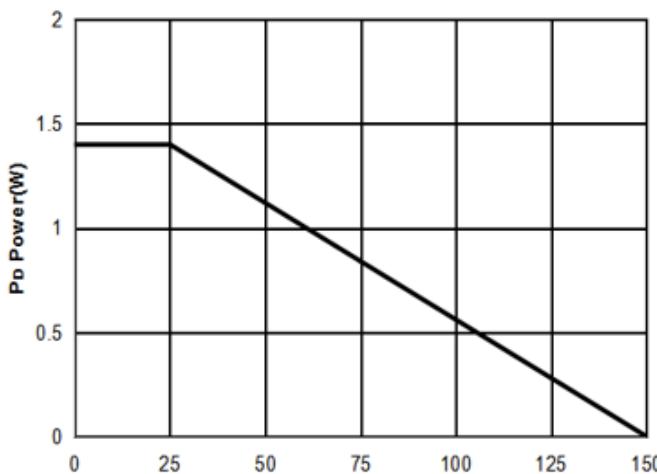
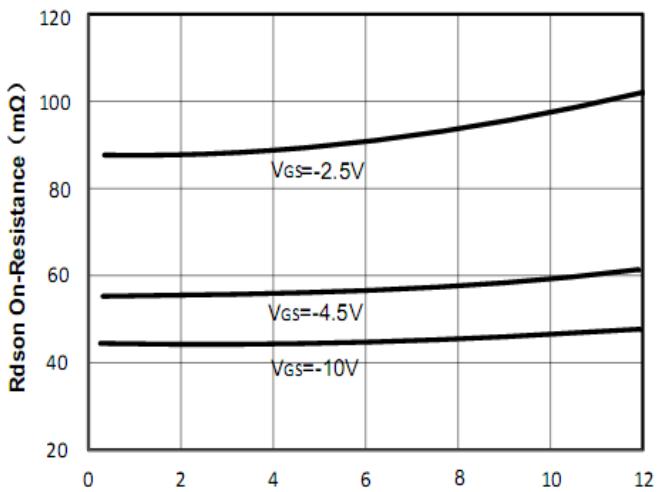
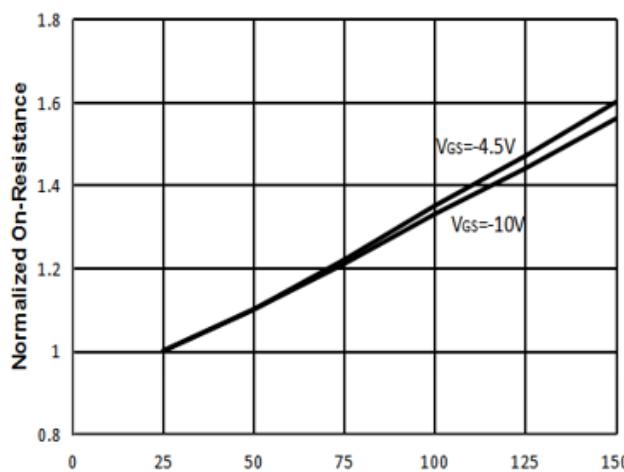
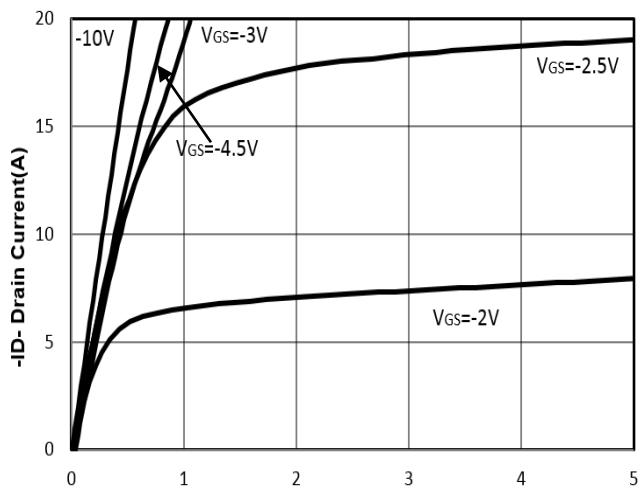
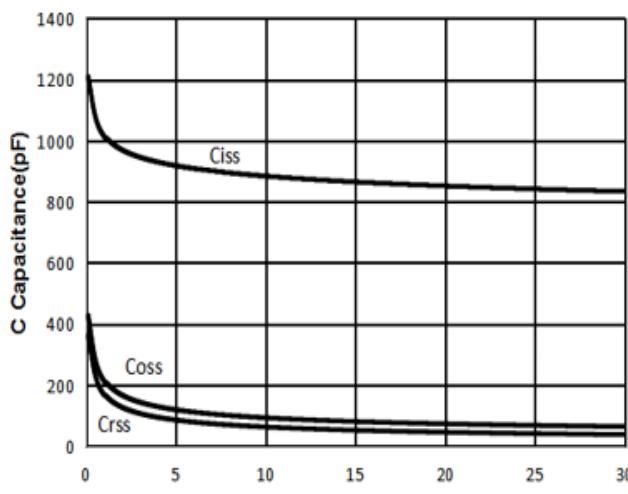
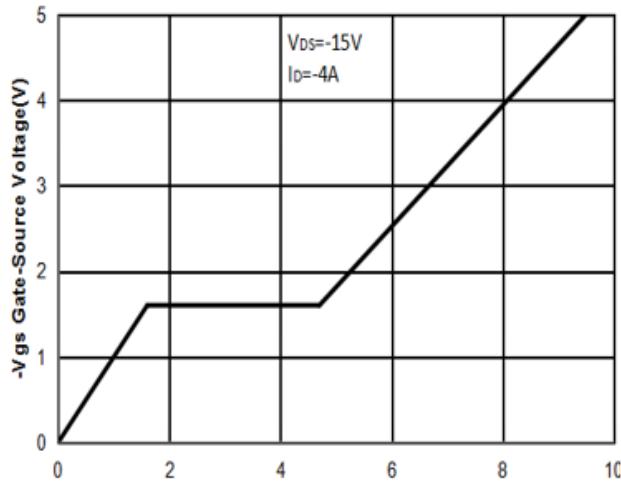


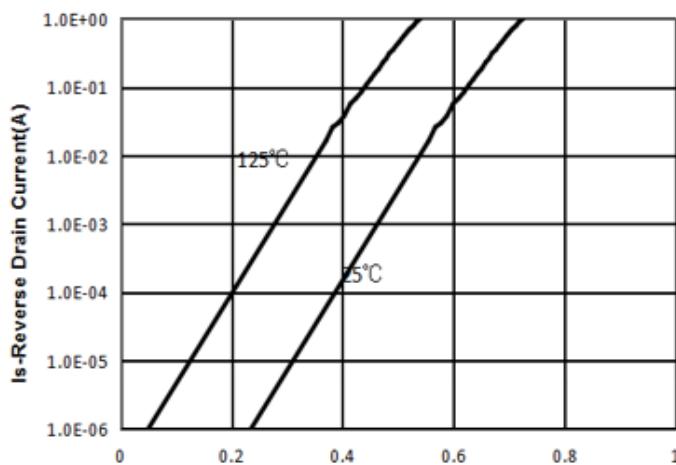
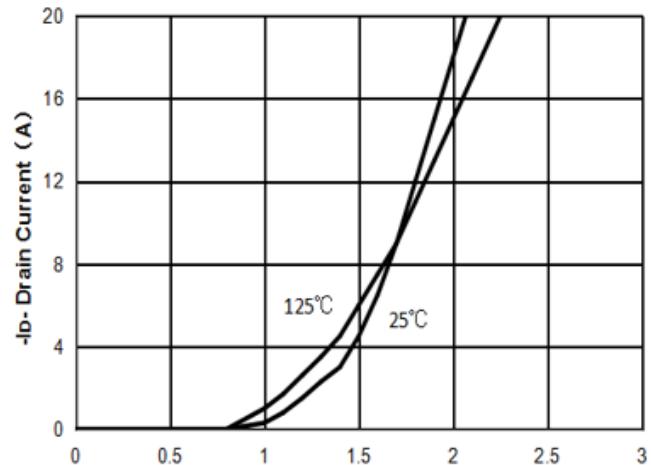
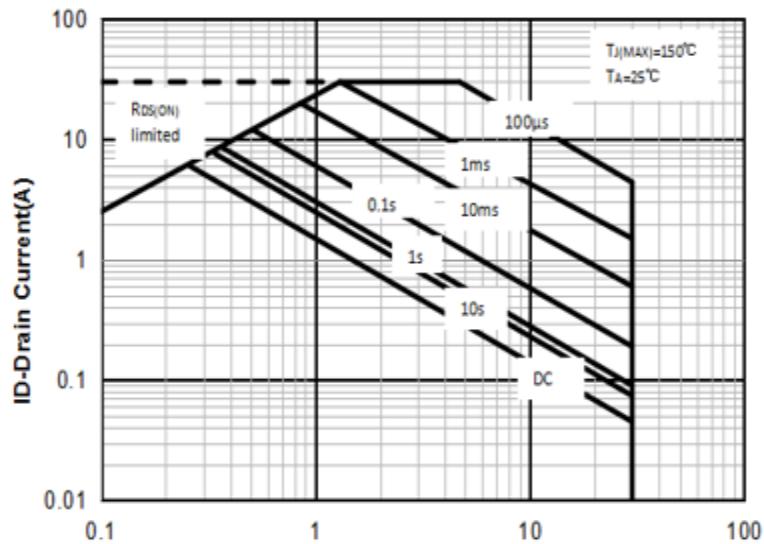
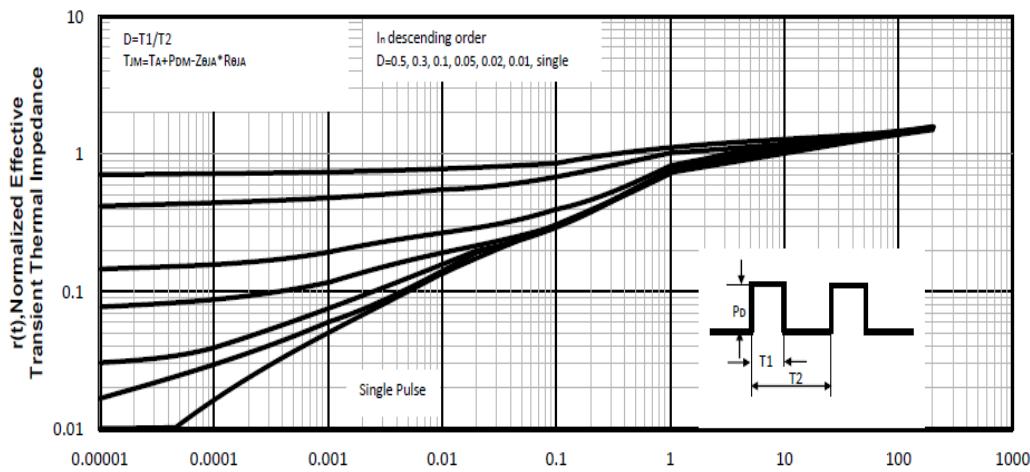
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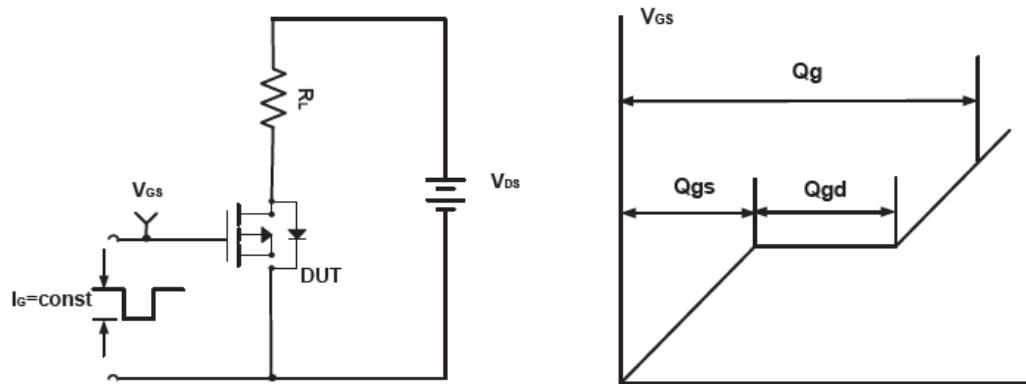
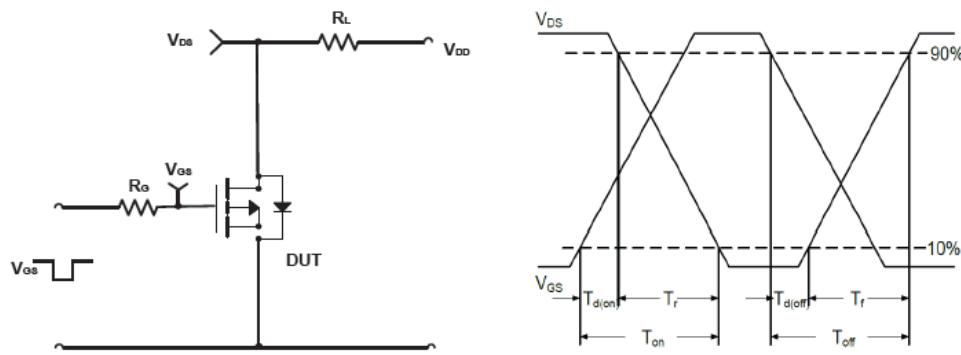
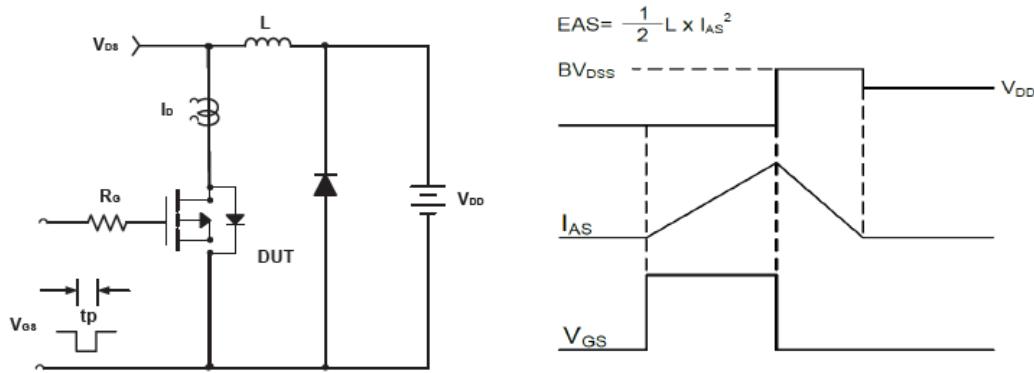
| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|---|--|--|------|------|-----------|-----------|
| Static Electrical Characteristics @ $T_J = 25^\circ C$ (unless otherwise stated) | | | | | | |
| $V_{(BR)DSS}$ | Drain- Source Breakdown Voltage | $V_{GS}=0V, ID=-250\mu A$ | -30 | -- | -- | V |
| I_{DSS} | Zero Gate Voltage Drain current | $V_{DS}=-24V, V_{GS}=0V$ | -- | -- | -1 | μA |
| I_{GSS} | Gate-Body Leakage Current | $V_{GS}=\pm 12V, V_{DS}=0V$ | -- | -- | ± 100 | nA |
| $V_{GS(TH)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, ID=-250\mu A$ | -0.7 | -1.6 | -1.3 | V |
| $R_{DS(ON)}$ | Drain-Source On-State Resistance (Note3) | $V_{GS}=-10V, ID=-4.2A$ | -- | 44 | 64 | $m\Omega$ |
| | | $V_{GS}=-4.5V, ID=-4A$ | -- | 57 | 75 | $m\Omega$ |
| | | $V_{GS}=-2.5V, ID=-1A$ | -- | 90 | 120 | $m\Omega$ |
| Dynamic Electrical Characteristics @ $T_J = 25^\circ C$ (unless otherwise stated) (Note4) | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = -15V, V_{GS} = 0V, F = 1MHz$ | -- | 954 | -- | pF |
| C_{oss} | Output Capacitance | | -- | 115 | -- | pF |
| C_{rss} | Reverse Transfer Capacitance | | -- | 77 | -- | pF |
| Q_g | Total Gate Charge | $V_{DS} = -15V, ID = -4A, V_{GS} = -10V$ | -- | 9.4 | -- | nC |
| Q_{gs} | Gate-Source Charge | | -- | 2 | -- | nC |
| Q_{gd} | Gate-Drain Charge | | -- | 3 | -- | nC |
| Switching Characteristics (Note4) | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = -15V, ID = -1A, RG = 3.7\Omega, V_{GS} = -10V$ | -- | 6.3 | -- | nS |
| t_r | Turn-on Rise Time | | -- | 3.2 | -- | nS |
| $t_{d(off)}$ | Turn-off Delay Time | | -- | 38.2 | -- | nS |
| t_f | Turn-off Fall Time | | -- | 12 | -- | nS |
| Source- Drain Diode Characteristics @ $T_J = 25^\circ C$ (unless otherwise stated) | | | | | | |
| V_{SD} | Forward on voltage (Note3) | $I_S = -1.8A, V_{GS} = 0V$ | -- | -- | -1.2 | V |

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec
3. Pulse Test: pulse width ≤ 300 us, duty cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production testing.

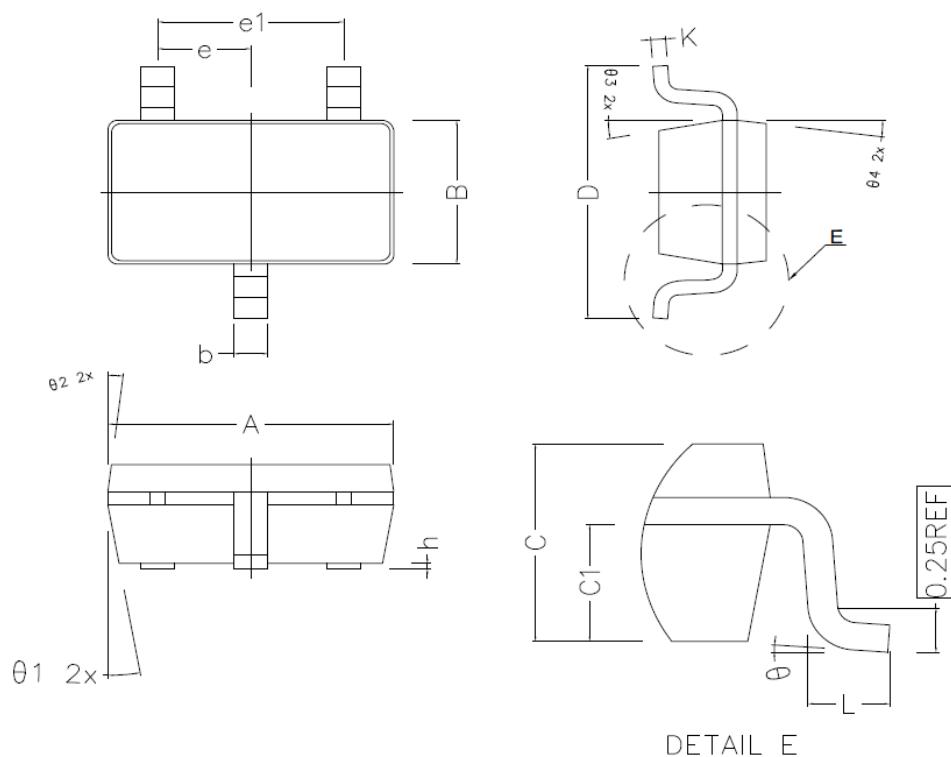
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Typical Characteristics

Figure1: TJ Junction Temperature (°C)

Figure2: -Id Drain Current (A)

Figure3: TJ Junction Temperature (°C)

Figure4: -VDS Drain-Source Voltage (V)

Figure5: -VDS Drain-Source Voltage (V)

Figure6: Qg Gate Charge (nC)

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Figure7: -Vsd Source-Drain Voltage (V)

Figure8: -Vgs Gate-Source Voltage (V)

Figure9: -Vds Drain -Source Voltage (V)

Figure10: Square Wave Pulse Duration (sec)

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Test Circuit and Waveform:

Figure A Gate Charge Test Circuit & Waveforms

Figure B Switching Test Circuit & Waveforms

Figure C Unclamped Inductive Switching Circuit & Waveforms

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SOT-23-3L Package Outline Dimensions (Units: mm)



| COMMON DIMENSIONS (UNITS OF MEASURE IS mm) | | | |
|---|-----------|--------|-------|
| | MIN | NORMAL | MAX |
| A | 2.820 | 2.920 | 3.020 |
| B | 1.500 | 1.600 | 1.700 |
| C | 1.050 | 1.100 | 1.150 |
| C1 | 0.600 | 0.650 | 0.700 |
| D | 2.650 | 2.800 | 2.950 |
| L | 0.300 | 0.450 | 0.600 |
| b | 0.280 | 0.350 | 0.420 |
| h | 0.020 | 0.050 | 0.100 |
| K | 0.120 | — | 0.230 |
| e | 0.950TYPE | | |
| e1 | 1.900TYPE | | |
| θ ₁ | 10° TYPE | | |
| θ ₂ | 7° TYPE | | |
| θ ₃ | 10° TYPE | | |
| θ ₄ | 7° TYPE | | |
| θ | 0° ~ 8° | | |